

Evaluation of the ADRF5292 High Isolation, Silicon SP4T, Nonreflective Switch, 0.1GHz to 13GHz

FEATURES

- ▶ Full-featured evaluation board for the [ADRF5292](#)
- ▶ Easy connection to the test equipment
- ▶ Thru line for calibration

EQUIPMENT NEEDED

- ▶ DC power supplies
- ▶ Network analyzer

GENERAL DESCRIPTION

The ADRF5292 is a SP4T switch manufactured in the silicon process.

This user guide describes the ADRF5292-EVALZ evaluation board, designed to evaluate the features and performance of the ADRF5292. [Figure 1](#) shows a photograph of the evaluation board.

Full specifications on the ADRF5292 are available in the ADRF5292 data sheet from Analog Devices, Inc. Consult the data sheet with this user guide when using the ADRF5292-EVALZ evaluation board.

ADRF5292-EVALZ EVALUATION BOARD PHOTOGRAPH

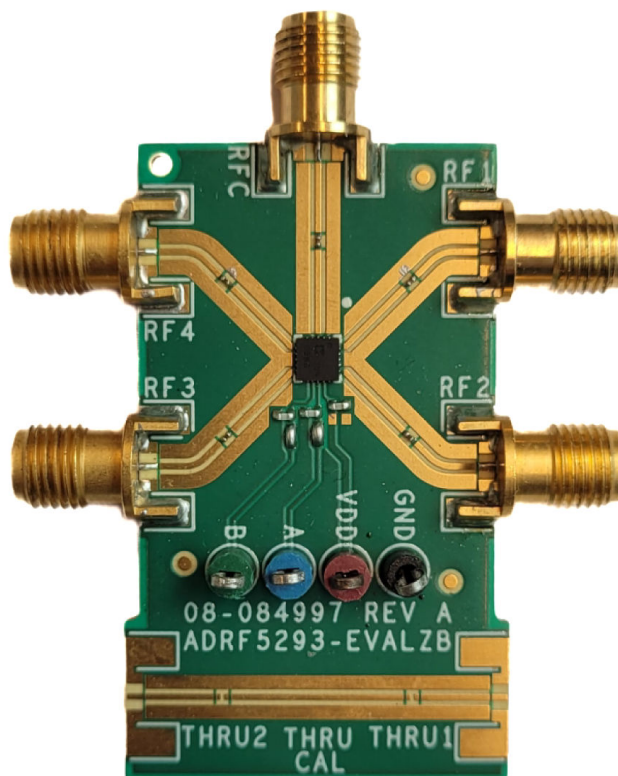


Figure 1. ADRF5292-EVALZ Evaluation Board Photograph

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REVISION HISTORY

10/2025—Revision 0: Initial Version

EVALUATION BOARD HARDWARE

OVERVIEW

The ADRF5292-EVALZ is a connectorized board, assembled with the ADRF5292 and its application circuitry. All components are placed on the primary side of the ADRF5292-EVALZ. An assembly drawing for the ADRF5292-EVALZ is shown in Figure 6, and an evaluation board schematic is shown in Figure 5.

BOARD LAYOUT

The ADRF5292-EVALZ is designed using RF circuit design techniques on a 4-layer printed circuit board (PCB). The PCB stack-up is shown in Figure 2.

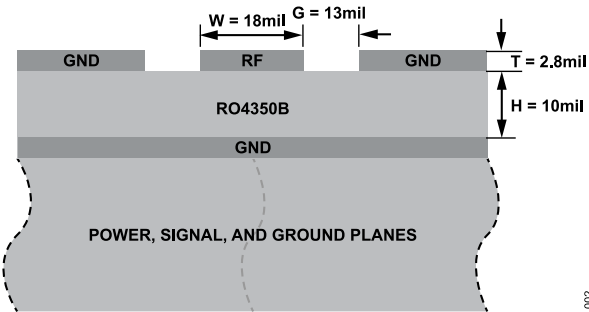


Figure 2. Evaluation Board Stack-Up

The outer copper layers are 2.8mil thick, and the inner layers are 1.4mil thick.

All RF and DC traces are routed on the top copper layer, whereas the inner and bottom layers are grounded planes that provide a solid ground for the RF transmission lines. The top dielectric material is 10mil Rogers RO4350B, offering optimal high-frequency performance. The middle and bottom dielectric materials provide mechanical strength. The total board thickness is 62mil, which allows edge launch RF connectors to be placed at the board edges.

The RF transmission lines are designed using a coplanar waveguide (CPWG) model with a width of 18mil and a ground spacing of 13mil to have a characteristic impedance of 50Ω. Ground via fences are arranged on both sides of the CPWG to improve isolation between nearby RF lines and other signal lines.

The exposed ground pad of the ADRF5292, which is soldered on the PCB ground pad, is the main thermal conduit for heat dissipation. The PCB ground pad is densely populated with filled, through vias to provide the lowest possible thermal resistance path from the top to the bottom of the PCB. The connections from the package ground leads to ground are kept as short as possible.

POWER SUPPLY AND CONTROL INPUTS

The ADRF5292-EVALZ has one power-supply input, two control inputs, and a ground, as shown in Table 1. The DC test points are populated on GND, VDD, V1, and V2. The ground reference must be connected to GND. The power supply (3.3V to 5V) is connected to the DC test point on VDD. Control inputs, V1 and V2, are connected to VDD (3.3V to 5V) or 0V. The typical supply current consumption for the ADRF5292 is 480μA with a 5V supply and 350μA with a 3.3V supply voltage.

The VDD supply pin of the ADRF5292 are decoupled with 100pF capacitor.

Table 1. Power-Supply and Control Inputs

Test Points	Description
VDD	Positive supply voltage
V1	Control Input 1
V2	Control Input 2
GND	Ground

EVALUATION BOARD HARDWARE

RF INPUTS AND OUTPUTS

The ADRF5292-EVALZ has five edge-mounted, 2.92mm connectors for the RF inputs and outputs, as shown in [Table 2](#).

Table 2. RF Inputs and Outputs

2.92mm Connectors	Description
RFC	RF common port
RF1	RF Throw Port 1
RF2	RF Throw Port 2
RF3	RF Throw Port 3
RF4	RF Throw Port 4
THRU1	Thru line input and output
THRU2	Thru line input and output

The through calibration line, connecting the THRU1 and THRU2 RF connectors, calibrates out the board loss effects from the measurements of the ADRF5292-EVALZ to determine the device performance at the pins of the IC. [Figure 3](#) shows the typical board loss for the ADRF5292-EVALZ at room temperature, as well as the embedded and de-embedded insertion loss for the [ADRF5292](#).

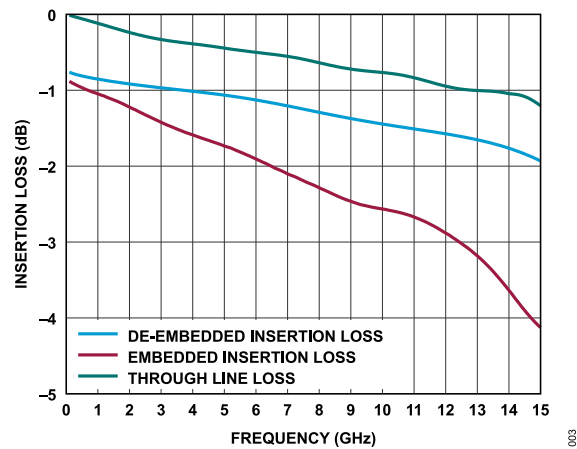


Figure 3. Insertion Loss vs. Frequency

TEST PROCEDURE

BIASING SEQUENCE

To bias up the ADRF5292-EVALZ, perform the following steps:

1. Ground the GND test point.
2. Bias up the VDD test point.
3. Bias up the V1 and V2 test points.
4. Apply an RF input signal.

The ADRF5292-EVALZ is shipped fully assembled and tested. Figure 4 provides a basic test setup diagram to evaluate the s-parameters using a network analyzer. Perform the following steps to complete the test setup and verify the operation of the ADRF5292-EVALZ:

1. Connect the GND test point to the ground terminal of the power supply.
2. Connect the VDD test point to the voltage-output terminal of the 3.3V to 5V supply.
3. Connect the V1 and V2 test points to the voltage-output terminal of the 3.3V supply. The ADRF5292 can be configured in different modes by connecting the V1 and V2 test points to 3.3V or 0V, as shown in Table 3.
4. Connect a calibrated network analyzer to the RFC, RF1, and RF2 2.92mm connectors. If the network analyzer port count is not enough, terminate unused RF ports with 50Ω. Sweep the frequency from 10MHz to 15GHz and set the power to -10dBm.

Additional test equipment is required to fully evaluate the functions and performance of the ADRF5292.

For third-order intercept point evaluation, use two signal generators and a spectrum analyzer. A high-isolation power combiner is also recommended.

Table 3. Control Voltage Truth Table

V1	V2	RFC to RF1	RFC to RF2	RFC to RF3	RFC to RF4
Low	Low	On	Off	Off	Off
High	Low	Off	On	Off	Off
Low	High	Off	Off	On	Off
High	High	Off	Off	Off	On

For power compression evaluation and power handling evaluation, use a 2-channel power meter and a signal generator. A high enough power amplifier is also recommended at the input. Test accessories, such as couplers and attenuators, must have enough power handling.

Note that the measurements performed at the 2.92mm connectors of the ADRF5292-EVALZ include the losses of the 2.92mm connectors and the PCB. The thru line must be measured to calibrate out the effects on the ADRF5292-EVALZ. The thru line is the summation of an RF input line and an RF output line that are connected to the ADRF5292-EVALZ and equal in length.

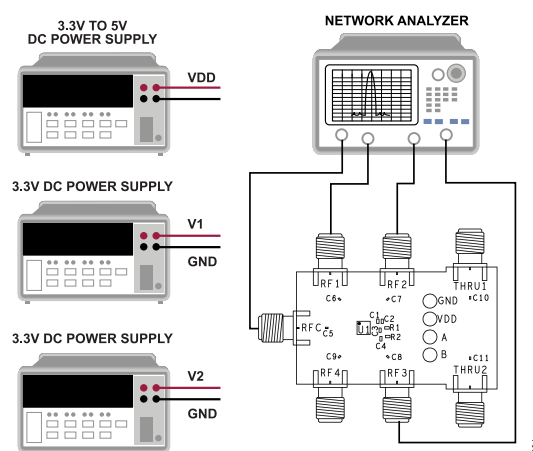


Figure 4. Test Setup Diagram

[illegible]

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ORDERING INFORMATION

EVALUATION BOARDS

Table 4. Evaluation Boards

Model ¹	Description
ADRF5292-EVALZ	Evaluation Board

¹ Z = RoHS-Compliant Part.

BILL OF MATERIALS

Table 5. Bill of Materials for ADRF5292-EVALZ

Quantity	Reference Designator	Description	Manufacturer	Part Number
1	C1	100pF ceramic capacitor, 50V, 5%, C0G, 0402, AEC-Q200	Murata	GCM1555C1H101JA16D
5	C5, C6, C7, C8, C9	0.1µF ceramic capacitors, 16V, 10%, 0201	Passive Plus Inc.	0201BB104KW
2	R1, R2	0Ω resistors, surface-mounted device (SMD), jumper, 1/8W, 0402, AEC-Q200	Vishay	RCC04020000Z0ED
5	RF1, RF2, RF3, RF4, RFC	Edge-mounted, 2.92mm connectors	SRI Connector Gage Co.	25-146-1000-92
1	U1	High isolation, silicon SPDT, nonreflective switch, 0.1GHz to 13GHz	Analog Devices	ADRF5292BCPZN
4	A, B, VDD, GND	Connector, PCB, testpoints	Keystone	5xxx
1	PCB	ADRF5292-EVALZ	Analog Devices	BR-084997a
2	C2	4.7µF ceramic capacitor, 16V, 20%, X5R, 0402, do not install (DNI)	Samsung	CL05A475MO5NUNC
1	C3, C4	100pF ceramic capacitors, 50V, 5% C0G, 0402, DNI	Murata	GCM1555C1H101JA16D
2	C10, C11	0.01µF ceramic capacitors, 25V, 10%, X7R, 0201, DNI	Passive Plus Inc.	0201BB103KW250
2	THRU1, THRU2	Edge-mount 2.92mm connectors, DNI	SRI Connector Gage Co.	25-146-1000-92

**ESD Caution**

ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

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